

MUREXIN

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MUREXIN Parquet Adhesive **X-Bond MS-K539**

- Innovative MSP adhesive
- Free from migratory components
- Free from water and solvents



The adhesive
of a new
generation!

MUREXIN. It lasts..



Parquet Adhesive X-Bond MS-K539

- Innovative MSP adhesive
- Elastic after setting
- Free from migratory components
- Wide range of application



Product properties

This high quality and single-component adhesive is free from water and solvents. This product is based on MSP technology and shows perfect processing properties – it can smoothly be spread and is therefore easy to process. The adhesive does not contain any migratory components and does not cause damaging interaction with MUREXIN parquet lacquers.

Application

It is suitable for indoor use only and is applied to bond strip parquet according to DIN EN 13226, on edge according to DIN EN 14761, mosaic parquet according to DIN EN 13489 and solid wood planks (maximum length 2200 mm, width 190 mm, thickness 22 mm) as well as for multilayer parquet (also single strips). The adhesive is suitable for underfloor heating systems.

Technical data

CONSUMPTION:	ca. 0,7 – 1,2 kg/m ² depending on the kind of parquet, substrate and trowel toothing	FINAL STRENGTH:	after approx. 48 hours
SPECIFIC WEIGHT:	1,6 g / cm ³	IDEAL PROCESSING TEMPERATURE:	+16 °Ct o +25 °C
PROCESSING PERIOD:	approx. 30 - 35 Minuten	PACKAGING:	plastic bucket of 16 kg

Application

RECOMMENDED INSTRUMENTS: Notched trowels B3, PK, B5, B17

SUBSTRATE: The substrate must be dry, frost-free and firm, load bearing, dimensionally stable and free from dust, dirt, oil, fat, separating agents and loose parts and must correspond to the current technical national and European standards, rules and to the “Generally Acknowledged Rules of the Trade”.

PRE-TREATMENT: Pre-treat the substrate using Murexin products. Appropriate priming: Primer **D7** and **PU 5 Express**. Priming can be omitted in the case of proper, standard substrates.

PROCESSING: Apply the adhesive evenly to the substrate using an appropriate notched trowel with big toothing. The laying period is approximately 30 to 35 minutes. Lay the parquet onto the adhesive bed moving it slightly into place and then pressing it down firmly in order to spread the adhesive across the entire reverse side of the parquet. You can walk over the parquet after approximately 24 hours. At low temperatures, the hardening process can be delayed. Polish the parquet flooring for the first time after at least 48 hours. The wood humidity at the time of laying must comply with the valid ÖNORM standards. Observe the parquet manufacturer’s instructions. The adhesive joint reduces shear forces and inhibits the transmission of damaging forces to the substrate. Remove adhesive stains from the parquet within a period of approximately 1 to 2 hours after laying rubbing them slightly. After setting, the adhesive can only be removed mechanically.

Hints

Only one working step: the special adhesive is ready for use. Therefore, no mixing is required. In the case of proper substrates, priming can be omitted – the parquet adhesive X-Bond MS-K539 sticks also to pale damp, cement-based substrates. This saves time and money!

All data are average values, which were determined under laboratory conditions. Due to the use of natural raw materials, the given data may slightly differ in a single lot without affecting the product suitability.

For the latest technical data sheet and safety data sheet as well as for the General Terms and Conditions, see our website: www.murexin.com.